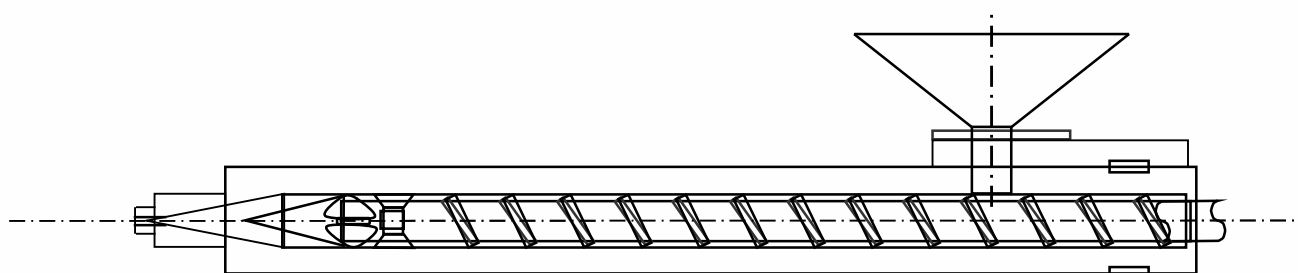


July 22, 2021 V1W

ABS, POLYLAC[®] PA-757 J01

Processing Conditions

- A Pre-drying 80°C x 2~3 hrs
depending on a) Humidity
b) Ratio of reground resin
c) Storage conditions
- B. Barrel Setting Profile



MAX(°C) 230	230	220
MIN(°C) 190	190	180

- C. Mold Temperature 30~70 °C
depending on a) Thickness
b) Dimension
c) Gate and runner system

NOTE :

1. Keep the resin from dust and contamination during handling and production.
2. Do not retain the hot melt at the barrel for a long time between injection cycles.
3. Temperature setting of manifold system should not exceed 240°C to avoid melt from degrading.

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